

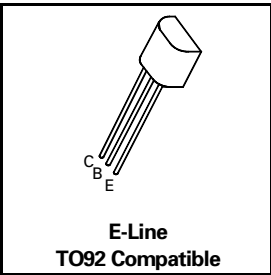
PNP SILICON PLANAR MEDIUM POWER HIGH GAIN TRANSISTOR

ZTX788A

PROVISIONAL DATASHEET ISSUE 2 – SEPTEMBER 94

FEATURES

- * 15 Volt V_{CEO}
- * Gain of 200 at $I_C=2$ Amps
- * Very low saturation voltage



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V_{CBO}	-20	V
Collector-Emitter Voltage	V_{CEO}	-15	V
Emitter-Base Voltage	V_{EBO}	-5	V
Peak Pulse Current	I_{CM}	-10	A
Continuous Collector Current	I_C	-3	A
Practical Power Dissipation*	P_{totp}	1.5	W
Power Dissipation at $T_{amb}=25^{\circ}C$ derate above $25^{\circ}C$	P_{tot}	1 5.7	W mW/ $^{\circ}C$
Operating and Storage Temperature Range	$T_j; T_{stg}$	-55 to +200	$^{\circ}C$

*The power which can be dissipated assuming the device is mounted in a typical manner on a P.C.B. with copper equal to 1 inch square minimum

ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}C$)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-20	-30		V	$I_C=-100\mu A$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	-15	-20		V	$I_C=-10mA^*$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-5	-8.5		V	$I_E=-100\mu A$
Collector Cut-Off Current	I_{CBO}			-0.1 -10	μA μA	$V_{CB}=-10V$ $V_{CB}=-10V, T_{amb}=100^{\circ}C$
Emitter Cut-Off Current	I_{EBO}			-0.1	μA	$V_{EB}=-4V$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$		-0.025 -0.25 -0.28	-0.035 -0.32 -0.33	V V V	$I_C=0.1A, I_B=2mA^*$ $I_C=2A, I_B=20mA^*$ $I_C=3A, I_B=200mA^*$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$		-0.85	-1.0	V	$I_C=2A, I_B=20mA^*$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$		-0.8		V	$I_C=2A, V_{CE}=-3V^*$
Static Forward Current Transfer Ratio	h_{FE}	300 250 200 80		800		$I_C=10mA, V_{CE}=1V^*$ $I_C=1A, V_{CE}=1V^*$ $I_C=2A, V_{CE}=1V^*$ $I_C=10A, V_{CE}=2V^*$

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ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Transition Frequency	f_T	100	150		MHz	$I_C = 50\text{mA}$, $V_{CE} = 5\text{V}$ $f = 50\text{MHz}$
Output Capacitance	C_{obo}		30	60	pF	$V_{CE} = 10\text{V}$, $f = 1\text{MHz}$
Switching Times	t_{on} t_{off}		40 500		ns ns	$I_C = 500\text{mA}$, $I_{B1} = 50\text{mA}$ $I_{B2} = 50\text{mA}$, $V_{CC} = 10\text{V}$

*Measured under pulsed conditions. Pulse width=300 μ s. Duty cycle $\leq 2\%$

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	MAX.	UNIT
Thermal Resistance: Junction to Ambient ₁	$R_{th(j-amb)1}$	175	$^{\circ}\text{C/W}$
Junction to Ambient ₂	$R_{th(j-amb)2}^{\dagger}$	116	$^{\circ}\text{C/W}$
Junction to Case	$R_{th(j-case)}$	70	$^{\circ}\text{C/W}$

$\dagger$ Device mounted on P.C.B. with copper equal to 1 sq. Inch minimum.

